

08-10-1998

FC, PTO-1595 (Modified)  
(Rev. 6-93)  
OMB No. 0651-0011 (exp. 4/94)  
Copyright 1994-97 LegalStar  
P08/REV02

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office



*MLA 7-30-98*

Tab settings

100789271

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

JCS50 U.S. PTO  
09/126169  
07/30/98

1. Name of conveying party(ies):

Katsuyuki Ogura and Yoshio Aihara

2. Name and address of receiving party(ies):

(1) DYFLEX CORPORATION  
Name: (2) AY CHEMICAL CO., LTD.

Internal Address:

Additional names(s) of conveying party(ies)  Yes;  No

3. Nature of conveyance:

- Assignment  Merger
- Security Agreement  Change of Name
- Other

Street Address: (1) 1-6, Jingumae 1-chome, Shibuya-ku, Tokyo 150 Japan and (2) 116, Kawaraguchi, Ebina-shi, Kanagawa 243-04, Japan

City: State: ZIP:

Execution Date: July 22, 1998

Additional name(s) & address(es) attached?  Yes  No

4. Application number(s) or registration numbers(s)

If this document is being filed together with a new application, the execution date of the application is: July 22, 1998

A. Patent Application No.(s)

B. Patent No.(s)

08/05/1998 PALLEH 00000001 09126169  
02 FC:581 40.00 GP

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: John F. Hoffman

Internal Address: BAKER & DANIELS

Street Address: 111 East Wayne Street, Suite 800

City: Fort Wayne State: IN ZIP: 46802

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$ 40.00

- Enclosed - Any excess or insufficiency should be credited or debited to deposit account
- Authorized to be charged to deposit account

8. Deposit account number:

02-0385

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

John F. Hoffman, Regis. No. 26,280

July 30, 1998

Name of Person Signing

Signature

PATENT

Date

Total number of pages including cover sheet, attachments, and document: 2

FILED: 9364 FRAME 0662

A S S I G N M E N T

WHEREAS, I/we, Katsuyuki OGURA and Yoshio AIHARA

residing at 8-13, Higashi-shinkoiwa 5-chome, Katsushika-ku, Tokyo 124 JAPAN;  
and 116, Kawaraguchi, Ebina-shi, Kanagawa 243-04 JAPAN

have invented certain improvements in:

"STRUCTURE OF SURFACE PORTIONS OF GROUNDS"  
described and claimed in an application for Letters Patent of the United States of America thereon, said application having been executed by me/us on even date herewith; and

DYFLEX CORPORATION and

WHEREAS, AY CHEMICAL CO., LTD., a corporation organized and existing under the laws of the Country of JAPAN, having its principal place of business at 1-6, Jingumae 1-chome, Shibuya-ku, Tokyo 150 JAPAN and 116, Kawaraguchi, Ebina-shi, Kanagawa 243-04 JAPAN (hereafter "Assignee"), is desirous of acquiring the entire right, title and interest in and to said application for Letters Patent;

NOW, THEREFORE, in consideration of the sum of ONE DOLLAR (\$1.00) to me/us in hand paid, and for other good and valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, I/we, by these presents do assign, sell, transfer and set over unto the said Assignee, its successors and assigns, the full, entire and exclusive right, title and interest, for the territory of the United States of America in and to said application identified above, and in and to any divisions or continuations or continuations-in-part thereof or substitutes therefor which may be filed, and in and to any patents or reissues, renewals or extensions thereof which may be granted on said application or for said invention; said invention, applications, and Letters Patent to be held and enjoyed by the said Assignee, for its own use and behoof and for its successors, heirs, or assigns, to the full end of the term or terms for which said Letters Patent may be granted, as fully and entirely as the same would have been held by said Assignee had this assignment and sale not been made.

I/we hereby authorize and request the Patent and Trademark Office Officials in the United States of America to issue any and all of said Letters Patent, when granted to said Assignee, as the Assignee of my/our entire right, title and interest in and to the same, for the sole use and enjoyment of said Assignee, its successors and assigns.

Further, I/we agree to execute all papers and to give such lawful testimony and to perform such other lawful acts as the said Assignee, its successors and assigns may require to enable it or them to procure Letters Patent on said invention or reissues or extensions thereof in the United States of America and/or to hold, enforce or convey said Letters Patent, reissues or extension.

Executed this 22 day of July, 1998.

Katsuyuki Ogura  
Katsuyuki OGURA Inventor

Yoshio Aihara  
Yoshio AIHARA Inventor

\_\_\_\_\_  
Inventor

\_\_\_\_\_  
Inventor

WITNESS:

Shunroku Ishii